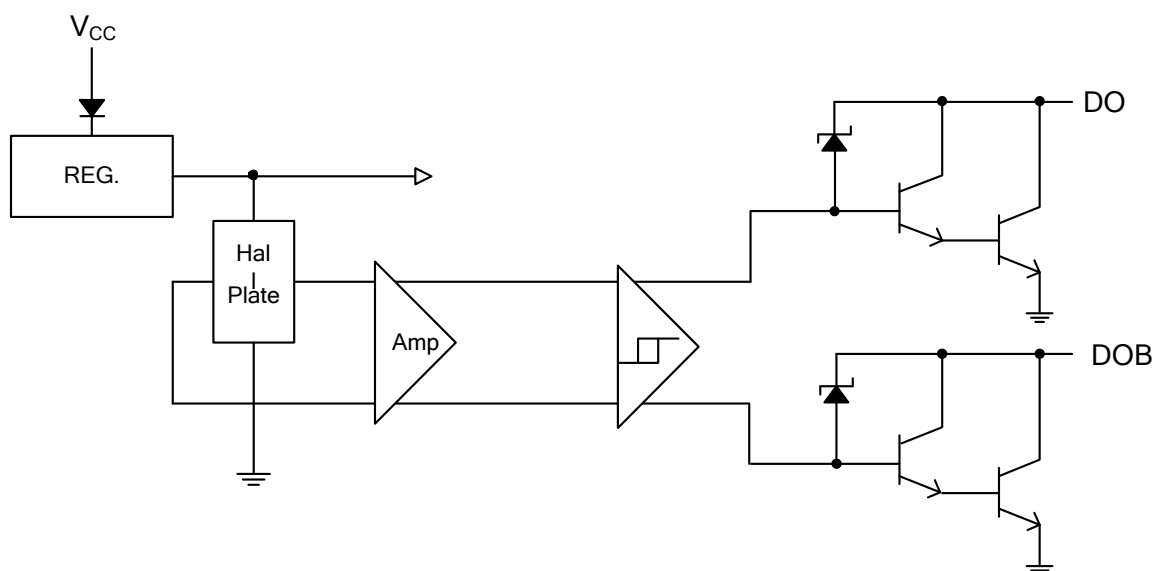


## Pin Descriptions

Pin Name	P/I/O	Pin #	Description
V <sub>CC</sub>	P	1	Power Supply Input
DO	O	2	Output Pin
DOB	O	3	Output Pin
GND	P	4	Ground

## Functional Block Diagram



## Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Rating	Unit
V <sub>CC</sub>	Supply Voltage	28	V
V <sub>out (off)</sub>	Output "OFF" Voltage	28	V
I <sub>O (con)</sub>	Output "ON" Current	400 (Note 5)	mA
I <sub>O (hold)</sub>		500	mA
I <sub>O (peak)</sub>		700	mA
B	Magnetic Flux Density	Unlimited	Gauss
T <sub>ST</sub>	Storage Temperature Range	-65 to +150	°C
P <sub>D</sub>	Power Dissipation (Note 6)	550	mW
θ <sub>JA</sub>	Thermal Resistance Junction-to-Ambient (SIP-4)	227	°C/W
θ <sub>JC</sub>	Thermal Resistance Junction-to-Case (SIP-4)	49	°C/W

## Recommended Operating Conditions (@T<sub>A</sub> = +25°C, unless otherwise specified.)

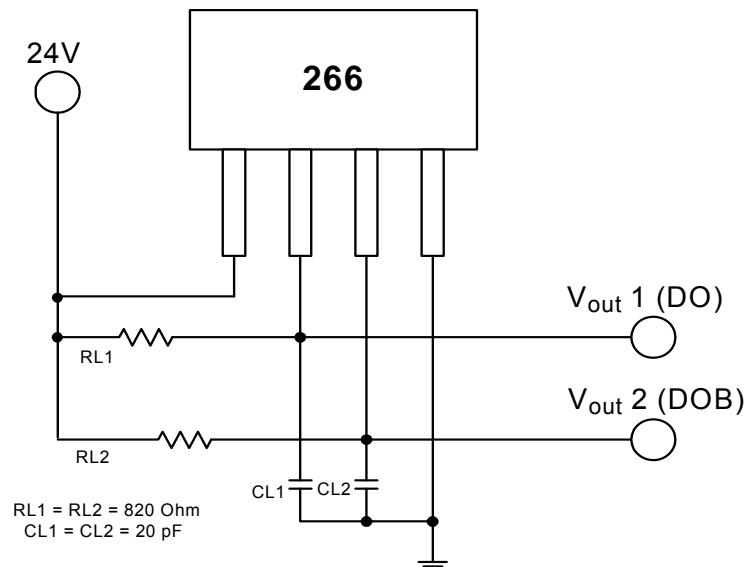
Symbol	Characteristic	Conditions	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage	Operating	4	28	V
T <sub>A</sub>	Operating Ambient Temperature (Note 7)	Operating	-20	85	°C

Notes: 4. This application circuit can't protect reverse coil current if power is connecting reverse.  
5. I<sub>O (con)</sub> is 150 mA at +85°C.  
6. See Performance Characteristics for other conditions.  
7. Shall not exceed P<sub>D</sub> and Safety Operation Area.

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Characteristic	Conditions	Min	Typ.	Max	Unit
V <sub>Z</sub>	Output Zener Breakdown	Output Turn off	54	62	70	V
V <sub>CE (SAT)</sub>	Output Saturation Voltage	V <sub>CC</sub> = 24V, I <sub>C</sub> = 400mA	—	1.1	1.5	V
I <sub>CEX</sub>	Output Leakage Current	V <sub>CE</sub> = 24V, V <sub>CC</sub> = 24V	—	< 0.1	10	μA
I <sub>CC</sub>	Supply Current	V <sub>CC</sub> = 24V, Output Open	—	5	10	mA
t <sub>r</sub>	Output Rise Time	V <sub>CC</sub> = 24V, R <sub>L</sub> = 820Ω, C <sub>L</sub> = 20pF	—	1.0	5	μs
t <sub>f</sub>	Output Falling Time	V <sub>CC</sub> = 24V, R <sub>L</sub> = 820Ω, C <sub>L</sub> = 20pF	—	1.0	1.5	μs
Δt	Switch Time Differential	V <sub>CC</sub> = 24V, R <sub>L</sub> = 820Ω, C <sub>L</sub> = 20pF	—	3.0	10	μs

## Test Circuit



## Magnetic Characteristics

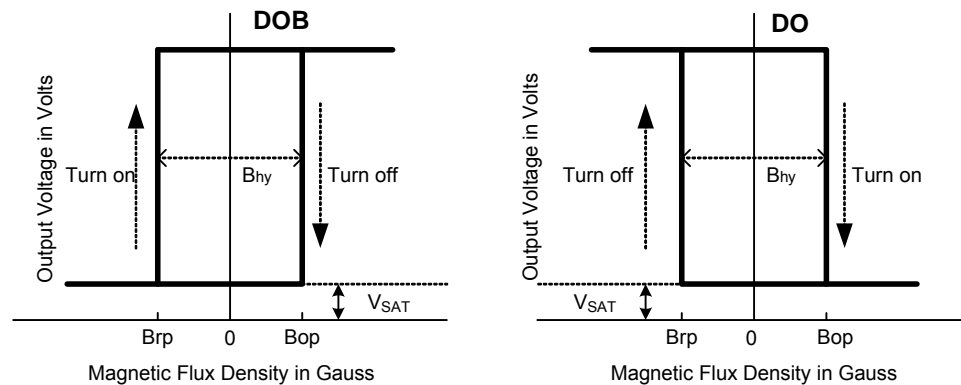
### A grade

(1mT = 10 Gauss)

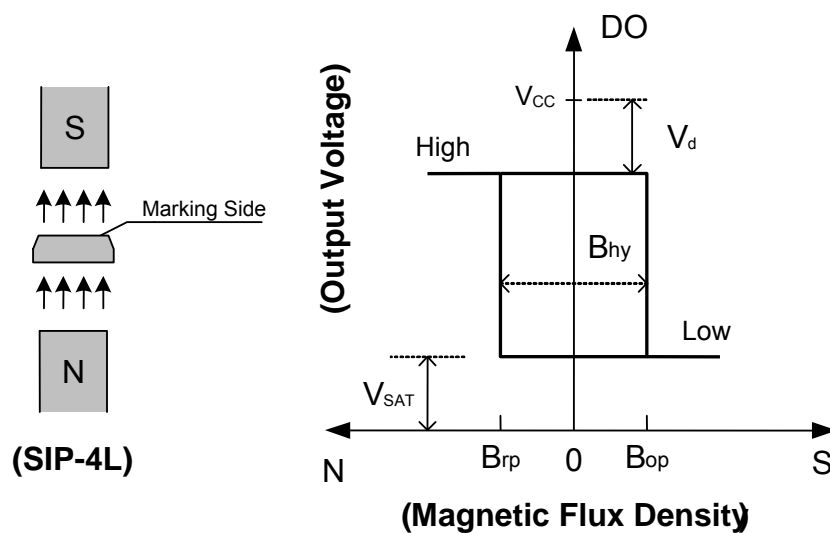
Symbol	Characteristic	Min	Typ.	Max	Unit
Bop	Operation Point	10	—	70	Gauss
Brp	Release Point	-70	—	-10	Gauss
Bhy	Hysteresis	—	80	—	Gauss

### B grade

Symbol	Characteristic	Min	Typ.	Max	Unit
Bop	Operation Point	—	—	100	Gauss
Brp	Release Point	-100	—	—	Gauss
Bhy	Hysteresis	—	80	—	Gauss

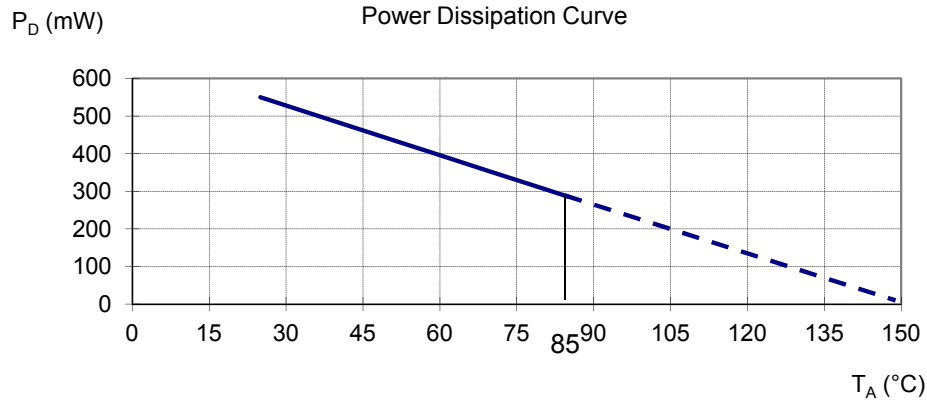


## Operation Characteristics

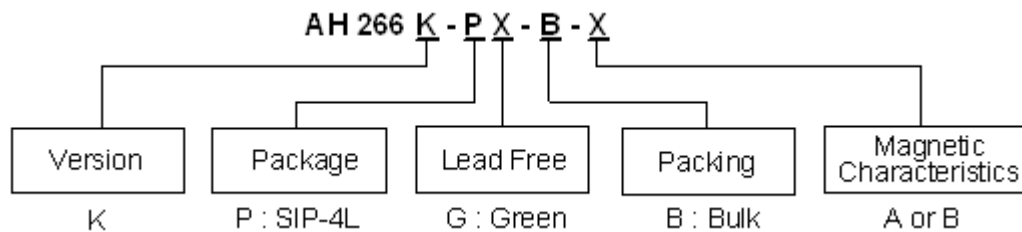


## Performance Characteristics

$T_A$ (°C)	25	50	60	70	80	85	90	95	100
$P_D$ (mW)	550	440	396	352	308	286	264	242	220
$T_A$ (°C)	105	110	115	120	125	130	135	140	150
$P_D$ (mW)	198	176	154	132	110	88	66	44	0



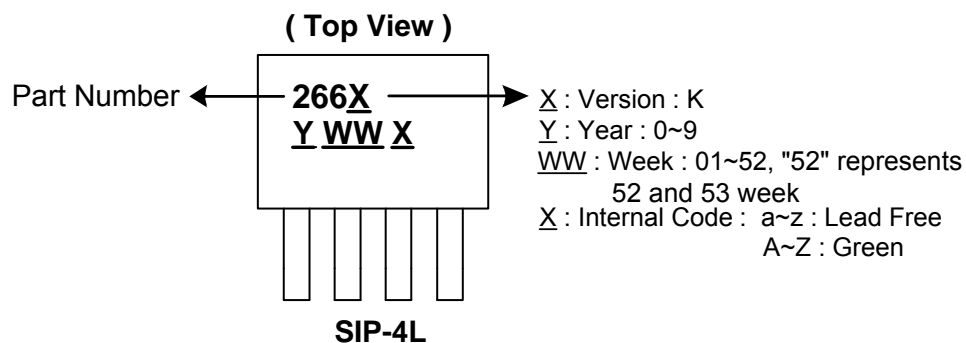
## Ordering Information



Device	Package Code	Packaging (Note 8)	Bulk		Magnetic Characteristics
			Quantity	Part Number Suffix	
AH266K-PG-B-A	P	SIP-4	1000	-B	A
AH266K-PG-B-B	P	SIP-4	1000	-B	B

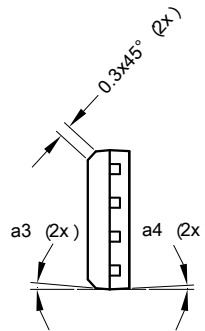
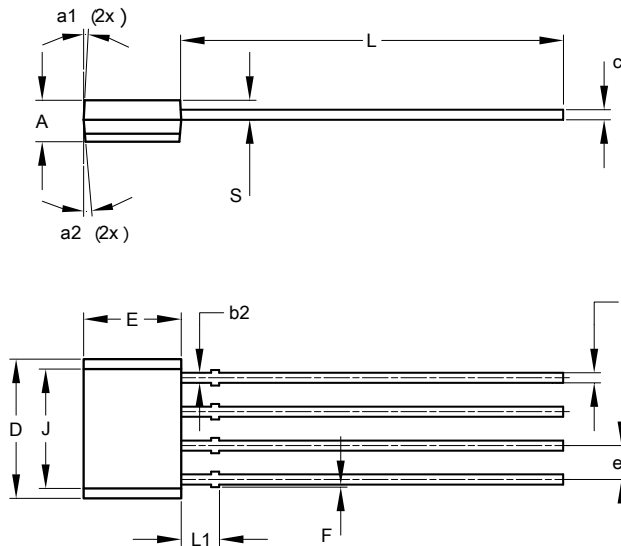
Note: 8. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>

## Marking Information



## Package Outline Dimensions (All dimensions in mm.)

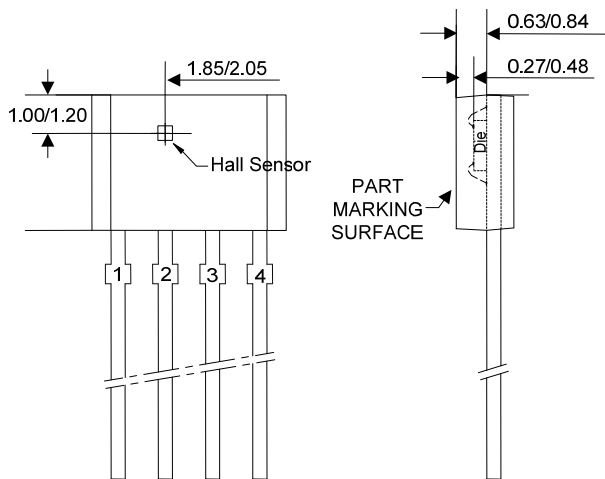
### (1) Package type: SIP-4L



SIP-4			
Dim	Min	Max	Typ
A	1.45	1.65	1.55
b1	0.38	0.44	0.40
b2	-	-	0.48
c	0.35	0.45	0.40
D	5.12	5.32	5.22
e1	1.24	1.30	1.27
E	3.55	3.75	3.65
F	0.00	0.20	-
J	4.10	4.30	4.20
L	14.00	14.60	14.30
L1	1.32	1.52	1.42
S	0.63	0.83	0.73
a1	-	5°	3°
a2	4°	7°	5°
a3	4°	7°	5°
a4	-	5°	3°

All Dimensions in mm

Min/Max (in mm)



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